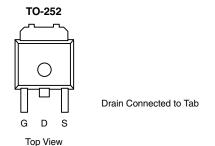




N-Channel 150-V (D-S) 175 °C MOSFET

PRODUCT SUMMARY						
V _{DS} (V)	$R_{DS(on)}(\Omega)$	I _D (A)				
150	0.052 at V _{GS} = 10 V	25				
130	0.060 at V _{GS} = 6 V	23				

• 175 $060 \text{ at V}_{GS} = 6 \text{ V}$ 23 • PWI • 100



Ordering Information:

SUD25N15-52-E3 (Lead (Pb)- free)

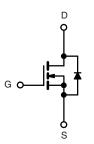
FEATURES

- TrenchFET® Power MOSFET
- 175 °C Junction Temperature
- PWM Optimized
- 100 % R_g Tested
- Compliant to RoHS Directive 2002/95/EC

RoHS

APPLICATIONS

· Primary Side Switch



N-Channel MOSFET

ABSOLUTE MAXIMUM RATINGS T _A = 25 °C, unless otherwise noted						
Parameter	Symbol	Limit	Unit			
Drain-Source Voltage	V _{DS}	150	V			
Gate-Source Voltage	V_{GS}	± 20	ď			
Continuous Drain Current (T _{.I} = 175 °C) ^b	T _C = 25 °C	L	25			
Continuous Drain Current (1 _J = 175 °C) ²	T _C = 125 °C	- I _D	14.5			
Pulsed Drain Current	I _{DM}	50	А			
Continuous Source Current (Diode Conduction)	Is	25				
Avalanche Current	I _{AR}	25				
Repetitive Avalanche Energy (Duty Cycle ≤ 1 %)	L = 0.1 mH	E _{AR}	31	mJ		
Maximum Daway Dissination	T _C = 25 °C	P _D	136 ^b	W		
Maximum Power Dissipation	T _A = 25 °C] 'D	3 ^a			
Operating Junction and Storage Temperature Range	T _J , T _{stg}	- 55 to 175	°C			

THERMAL RESISTANCE RATINGS							
Parameter		Symbol	Typical	Maximum	Unit		
lunation to Ameliand	t ≤ 10 s	- R _{thJA}	15	18	°C/W		
Junction-to-Ambient ^a	Steady State		40	50			
Junction-to-Case (Drain)		R _{thJC}	0.85	1.1			

Notes:

- a. Surface Mounted on 1" x 1" FR4 board.
- b. See SOA curve for voltage derating.

SUD25N15-52

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SPECIFICATIONS T _J = 25 °C, unless otherwise noted							
Parameter	Symbol	Test Conditions	Min.	Typ. ^a	Max.	Unit	
Static							
Drain-Source Breakdown Voltage	V_{DS}	$V_{GS} = 0 \text{ V}, I_D = 250 \mu\text{A}$	150			V	
Gate Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}, I_D = 250 \mu A$	2		4	V	
Gate-Body Leakage	I _{GSS}	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 20 \text{ V}$			± 100	nA	
		V _{DS} = 150 V, V _{GS} = 0 V			1		
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} = 150 V, V _{GS} = 0 V, T _J = 125 °C			50	μΑ	
		V _{DS} = 150 V, V _{GS} = 0 V, T _J = 175 °C			250		
On-State Drain Current ^b	I _{D(on)}	V _{DS} = 5 V, V _{GS} = 10 V	50			Α	
		V _{GS} = 10 V, I _D = 5 A		0.042	0.052	Ω	
5	В	V _{GS} = 10 V, I _D = 5 A, T _J = 125 °C			0.109		
Drain-Source On-State Resistance ^b	R _{DS(on)}	V _{GS} = 10 V, I _D = 5 A, T _J = 175 °C			0.145		
		V _{GS} = 6 V, I _D = 5 A		0.047	0.060		
Forward Transconductance ^b	9 _{fs}	V _{DS} = 15 V, I _D = 25 A		40		S	
Dynamic ^a							
Input Capacitance	C _{iss}			1725		pF	
Output Capacitance	C _{oss}	$V_{GS} = 0 \text{ V}, V_{DS} = 25 \text{ V}, f = 1 \text{ MHz}$		216			
Reverse Transfer Capacitance	C _{rss}			100			
Total Gate Charge ^c	Q_g			33	40		
Gate-Source Charge ^c	Q _{gs}	$V_{DS} = 75 \text{ V}, V_{GS} = 10 \text{ V}, I_{D} = 25 \text{ A}$		9		nC	
Gate-Drain Charge ^c	Q_{gd}			12			
Gate Resistance	R_g		1		3	Ω	
Turn-On Delay Time ^c	t _{d(on)}			15	25		
Rise Time ^c	t _r	$V_{DD} = 50 \text{ V}, R_L = 3 \Omega$		70	100		
Turn-Off Delay Time ^c	t _{d(off)}	$I_D \cong 25 \text{ A}, V_{GEN} = 10 \text{ V}, R_g = 2.5 \Omega$		25	40	ns	
Fall Time ^c	t _f			60	90		
Source-Drain Diode Ratings and Characteristics T_C = 25 $^{\circ}C$							
Pulsed Current	I _{SM}				50	Α	
Diode Forward Voltage ^b	V_{SD}	I _F = 25 A, V _{GS} = 0 V		0.9	1.5	V	
Source-Drain Reverse Recovery Time	t _{rr}	I _F = 25 A, dI/dt = 100 A/μs		95	140	ns	

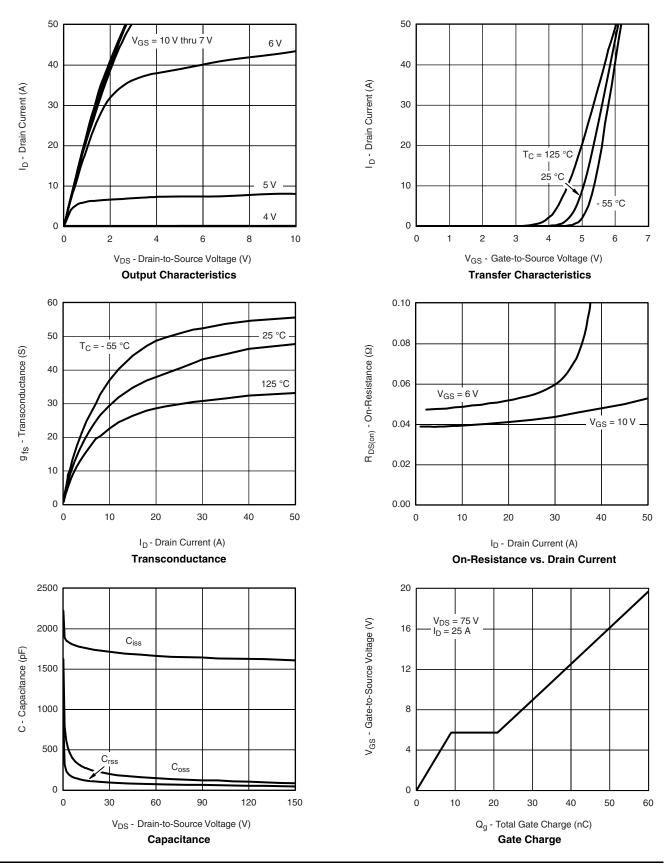
Notes:

- a. Guaranteed by design, not subject to production testing.
- b. Pulse test; pulse width \leq 300 μ s, duty cycle \leq 2 %.
- c. Independent of operating temperature.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.



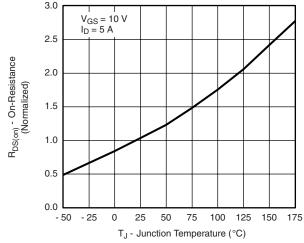
TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



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TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted

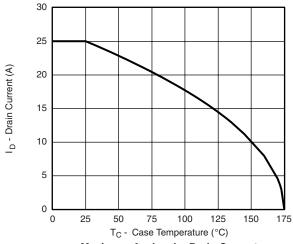


On-Resistance vs. Junction Temperature

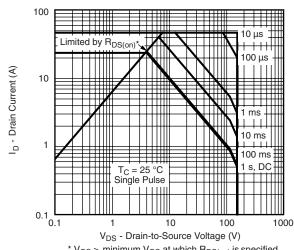
$T_{J} = 150 \, ^{\circ}\text{C}$ T_J = 150 $^{\circ}\text{C}$ T_J = 25 $^{\circ}\text{C}$ T_{SD} - Source-to-Drain Voltage (V)

Source-Drain Diode Forward Voltage

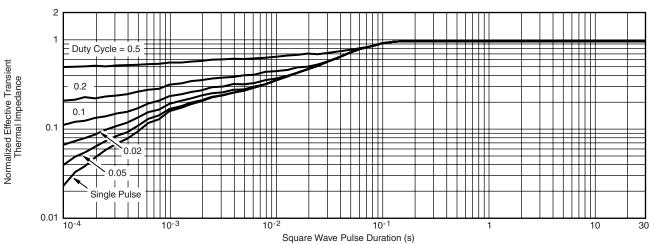
THERMAL RATINGS



Maximum Avalanche Drain Current vs. Case Temperature

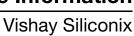


* V_{GS} > minimum V_{GS} at which $R_{DS(on)}$ is specified **Safe Operating Area**



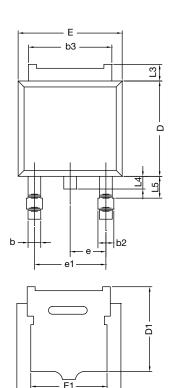
Normalized Thermal Transient Impedance, Junction-to-Case

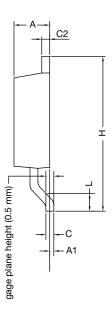
Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package/tape drawings, part marking, and reliability data, see www.vishay.com/ppg?71768.





TO-252AA Case Outline





	MILLIMETERS		INC	HES	
DIM.	MIN.	MAX.	MIN.	MAX.	
Α	2.18	2.38	0.086	0.094	
A1	-	0.127	-	0.005	
b	0.64	0.88	0.025	0.035	
b2	0.76	1.14	0.030	0.045	
b3	4.95	5.46	0.195	0.215	
С	0.46	0.61	0.018	0.024	
C2	0.46	0.89	0.018	0.035	
D	5.97	6.22	0.235	0.245	
D1	4.10	-	0.161	-	
Е	6.35	6.73	0.250	0.265	
E1	4.32	-	0.170	-	
Н	9.40	10.41	0.370	0.410	
е	2.28 BSC		0.090 BSC		
e1	4.56 BSC		0.180	BSC	
L	1.40	1.78	0.055	0.070	
L3	0.89	1.27	0.035	0.050	
L4	-	1.02	-	0.040	
L5	1.01	1.52	0.040	0.060	
ECN: T16-0236-Rev. P, 16-May-16					

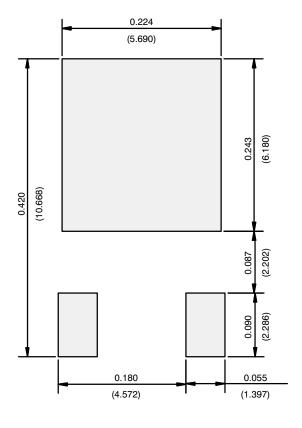
DWG: 5347

Notes

• Dimension L3 is for reference only.



RECOMMENDED MINIMUM PADS FOR DPAK (TO-252)



Recommended Minimum Pads Dimensions in Inches/(mm)

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APPLICATION NOTE



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